

## Selecting the Best bq2425x Single Cell I2C, Standalone Switch-Mode Battery Charger for your Application

Tahar Allag / James Smith

## **ABSTRACT**

The bq2425x series of devices are highly integrated Li-Ion, Li-Pol, and LiFePO4 linear chargers devices targeted at space limited portable applications. The devices operate from either a USB port or AC adapter. This application note provides a selection table that highlights different specification and feature of these bq2425x chargers. In application where both Standalone and I2C devices are needed, the bq24250, bq24251, and bq24257 can be used. If a power path is required, consider using the bq24250, bq24251 and bq24253.

**Table 1. Selection Table** 

Specification or Feature (19)	bq24250	bq24251	bq24253	bq24253H	bq24257	bq24258
Default Battery Regulation Voltage (V)	4.2	4.2	4.2	4.34	4.2	4.2
Minimum Vin (V) (1)	4.35	4.35	4.35	4.35	4.35	4.35
Maximum Vin (V) (2)	10.5	10.5	10.5	10.5	6.5	10.5
EN1/EN2 (2)	YES	NO	YES	YES	NO	YES
D+/D- Detection (3)	NO	YES	YES	YES	YES	NO
Battery Chemistry	Li-Ion/Li-Po	Li-Ion/Li-Po	Li-Ion/Li-Po	Li-Ion/Li-Po	Li-Ion/Li-Po	LiFePO4
USB/AC	YES	YES	YES	YES	YES	YES
Status Indicator	INT <sup>(4)</sup> /STAT <sup>(5)</sup>	PG <sup>(6)</sup> /STAT <sup>(5)</sup>	PG <sup>(6)</sup> /CHG <sup>(7)</sup>	PG <sup>(6)</sup> /CHG <sup>(7)</sup>	PG <sup>(6)</sup> /STAT <sup>(5)</sup>	PG <sup>(6)</sup> /STAT <sup>(5)</sup>
Voltage based TS <sup>(8)</sup>	YES	YES	YES	YES	YES	YES
Max Input Charge Current (A)	2A	2A	2A	2A	2A	2A
Operation Mode	I2C / Standalone	I2C / Standalone	Standalone	Standalone	I2C / Standalone	Standalone
JEITA Compatible (9)	YES	YES	YES	YES	YES	YES
Production Test Mode (10)	YES	YES	NO	NO	YES	NO
SYS/CIN Bypass Cap (min)	20µF	20µF	20μF	20µF	1µF	1μF
Safety Timer (11)	YES	YES	YES	YES	YES	YES
Watchdog Timer (12)	YES	YES	NO	NO	YES	NO
Power-Path MGMT (13)	YES	YES	YES	YES	NO	NO
Input OVP (14)	YES	YES	YES	YES	YES	YES
MINSYS (15)	3.5V	3.5V	3.5V	3.5V	N/A	N/A
Thermal Regulation/Shutdown (16)	YES	YES	YES	YES	YES	YES
VIN DPM (17)	YES	YES	YES	YES	YES	YES
Package (18)	WCSP-30 /QFN - 24					

- (1) Recommended Min/Max input voltage in which IC is operational. The IC also have input over voltage protect that can be set from 6V to 10.5V using I2C commands.
- (2) Input Current Limit Configuration Inputs: Controls input current and USB compliance. Selectable Input Current Limit include; 100mA, 150mA, 500mA, 900mA, 1.5A, and 2A. For the bq24258, the EN3 is also available to support USB 3.0 compliance.
- (3) BC1.2 detection: D+ and D- can detect types of USB adaptors and adjust the maximum input current accordingly
- (4) INT Charge Status Indication and Fault Interrupts: Low (FET on) indicates charging and Open Drain (FET off) indicates no Charging or Charge complete. When a fault occurs, a 256µs pulse is sent as an indication to the external host. Also indicates recharge cycles.
- (5) Similar function as INT pin (4). The only difference is it can be disabled via I2C on EN\_STAT bit on register 2.
- (6) PG or Power Good: Low (FET on) indicates the input voltage is above UVLO and the OUT (battery) voltage.

All trademarks are the property of their respective owners.



- (7) CHG is a Charge Status Indication: Low (FET on) indicates charging and Open Drain (FET off) indicates no Charging or absence of a supply. This status pin does not indicate recharge cycles.
- (8) Voltage based NTC: The TS function provides 4 thresholds for JEITA compatibility (PSE also available upon request). The voltage based NTC monitor allows for the use of any NTC resistor with adding external resistors.
- (9) The IC includes the integration of an NTC monitor pin that complies with the JEITA specification (PSE also available upon request).
- (10) PTM or Product Test Mode: In this mode the input current limit to the charger is disabled and the output current limit is limited only by the inductor cycle-by-cycle current. This feature is useful for device product manufacturing testing. This feature is disabled by default for SA spins.
- (11) Safety Timer: The main purpose of this function is to prevent continuous charging of a defective battery. The safety timer time is selectable using the I2C interface to 45min, 6hrs, or 9hrs. It set by default to 6 hours non-adjustable for SA devices.
- (12) Watchdog Timer: it is an optional dynamic safety timer that monitors host through the I2C interface. If the watchdog timer expires, the IC enters DEFAULT mode where the default charge parameters are loaded and charging continues.
- (13) Power Path management: Allows IC to power the system from a high efficiency DC/DC converter while simultaneously and independently charging the battery. Also permits the battery to supplement the system current requirements when the adapter cannot deliver the peak system and battery load requirements.
- (14) Input OVP: Input over-voltage protection is built to protect the IC against damage from over voltage on the input supply. When VIN > VOVP, the bq2425x turns off the PWM converter, turns on the battery FET. The OVP threshold is programmable from 6 V to 10.5 V using VOVP bits in register #7 on the I2C devices. For the SA devices, the default OVP is applied.
- (15) MINSYS: Minimum system voltage regulation.
- (16) Thermal Regulation: The bq2425x will taper down the charge current in order to protect itself when the junction temperature of the die exceeds 125°C. Thermal Shutdown Protection: The bq2425x will completely cut off the charge current and disables the buck converter in order to protect the IC when the junction temperature of the die exceeds 150°C.
- (17) VINDPM or input voltage based dynamic power management: If the input power supply reaches its current limit, the voltage decreases. This feature monitors the input voltage, and once it drops below VIN\_DPM threshold, the input current limit is reduced to prevent further drop in the VIN. The VIN\_DPM can be set externally or using I2C.
- (18) Package Type
- (19) If other features and specs are needed from this family, contact local TI sales office for more information. Note that the bq24258 and 24253H are in product preview devices.

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have *not* been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products Applications

Audio www.ti.com/audio Automotive and Transportation www.ti.com/automotive Communications and Telecom **Amplifiers** amplifier.ti.com www.ti.com/communications **Data Converters** dataconverter.ti.com Computers and Peripherals www.ti.com/computers **DLP® Products** www.dlp.com Consumer Electronics www.ti.com/consumer-apps

DSP **Energy and Lighting** dsp.ti.com www.ti.com/energy Clocks and Timers www.ti.com/clocks Industrial www.ti.com/industrial Interface interface.ti.com Medical www.ti.com/medical logic.ti.com Logic Security www.ti.com/security

Power Mgmt power.ti.com Space, Avionics and Defense www.ti.com/space-avionics-defense

Microcontrollers <u>microcontroller.ti.com</u> Video and Imaging <u>www.ti.com/video</u>

RFID www.ti-rfid.com

OMAP Applications Processors <u>www.ti.com/omap</u> TI E2E Community <u>e2e.ti.com</u>

Wireless Connectivity <u>www.ti.com/wirelessconnectivity</u>